

# Low-Voltage CMOS Octal Transparent Latch

With 5 V-Tolerant Inputs and Outputs  
(3-State, Non-Inverting)

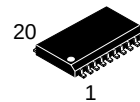
## MC74LCX373

The MC74LCX373 is a high performance, non-inverting octal transparent latch operating from a 2.3 to 3.6 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A  $V_I$  specification of 5.5 V allows MC74LCX373 inputs to be safely driven from 5 V devices.

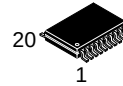
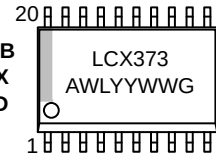
The MC74LCX373 contains 8 D-type latches with 3-state outputs. When the Latch Enable (LE) input is HIGH, data on the Dn inputs enters the latches. In this condition, the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-state standard outputs are controlled by the Output Enable ( $\overline{OE}$ ) input. When  $\overline{OE}$  is LOW, the standard outputs are enabled. When  $\overline{OE}$  is HIGH, the standard outputs are in the high impedance state, but this does not interfere with new data entering into the latches.

### Features

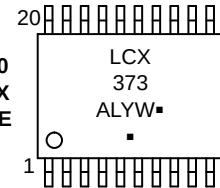
- Designed for 2.3 to 3.6 V  $V_{CC}$  Operation
- 5 V Tolerant – Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- $I_{OFF}$  Specification Guarantees High Impedance When  $V_{CC} = 0$  V
- LVTTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in all Three Logic States (10  $\mu$ A)  
Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance:
  - ♦ Human Body Model >2000 V
  - ♦ Machine Model >200 V
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



SOIC-20 WB  
DW SUFFIX  
CASE 751D



TSSOP-20  
DT SUFFIX  
CASE 948E



LCX373 = Specific Device Code  
 A = Assembly Location  
 L, WL = Wafer Lot  
 Y, YY = Year  
 W, WW = Work Week  
 G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

# MC74LCX373

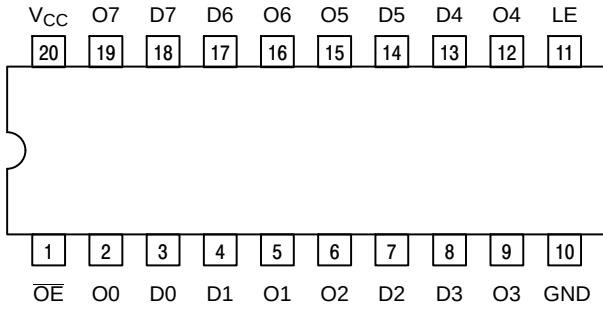


Figure 1. Pinout (Top View)

## PIN NAMES

| PINS  | FUNCTION              |
|-------|-----------------------|
| OE    | Output Enable Input   |
| LE    | Latch Enable Input    |
| D0-D7 | Data Inputs           |
| O0-O7 | 3-State Latch Outputs |

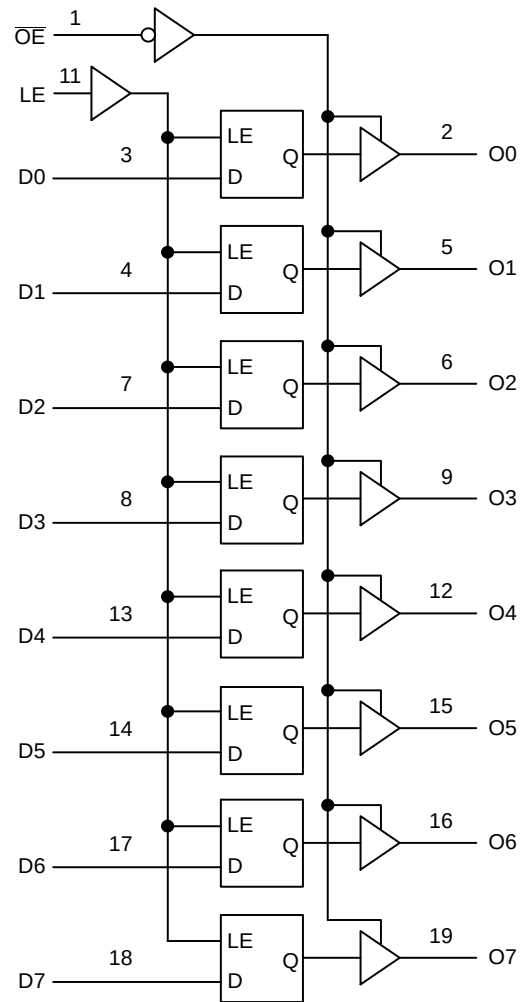


Figure 2. Logic Diagram

## TRUTH TABLE

| INPUTS |    |    | OUTPUTS | OPERATING MODE                                 |
|--------|----|----|---------|------------------------------------------------|
| OE     | LE | Dn | On      |                                                |
| L      | H  | H  | H       | Transparent (Latch Disabled); Read Latch       |
| L      | H  | L  | L       |                                                |
| L      | L  | h  | H       | Latched (Latch Enabled) Read Latch             |
| L      | L  | l  | L       |                                                |
| L      | L  | X  | NC      | Hold; Read Latch                               |
| H      | L  | X  | Z       | Hold; Disabled Outputs                         |
| H      | H  | H  | Z       | Transparent (Latch Disabled); Disabled Outputs |
| H      | H  | L  | Z       |                                                |
| H      | L  | h  | Z       | Latched (Latch Enabled); Disabled Outputs      |
| H      | L  | l  | Z       |                                                |

H = High Voltage Level

h = High Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition

L = Low Voltage Level

l = Low Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition

NC = No Change, State Prior to the Latch Enable High-to-Low Transition

X = High or Low Voltage Level or Transitions are Acceptable

Z = High Impedance State

For I<sub>CC</sub> Reasons DO NOT FLOAT Inputs

# MC74LCX373

## MAXIMUM RATINGS

| Symbol    | Parameter                        | Value                             | Condition                            | Units |
|-----------|----------------------------------|-----------------------------------|--------------------------------------|-------|
| $V_{CC}$  | DC Supply Voltage                | -0.5 to +7.0                      |                                      | V     |
| $V_I$     | DC Input Voltage                 | $-0.5 \leq V_I \leq +7.0$         |                                      | V     |
| $V_O$     | DC Output Voltage                | $-0.5 \leq V_O \leq +7.0$         | Output in 3-State                    | V     |
|           |                                  | $-0.5 \leq V_O \leq V_{CC} + 0.5$ | Output in HIGH or LOW State (Note 1) | V     |
| $I_{IK}$  | DC Input Diode Current           | -50                               | $V_I < GND$                          | mA    |
| $I_{OK}$  | DC Output Diode Current          | -50                               | $V_O < GND$                          | mA    |
|           |                                  | +50                               | $V_O > V_{CC}$                       | mA    |
| $I_O$     | DC Output Source/Sink Current    | $\pm 50$                          |                                      | mA    |
| $I_{CC}$  | DC Supply Current Per Supply Pin | $\pm 100$                         |                                      | mA    |
| $I_{GND}$ | DC Ground Current Per Ground Pin | $\pm 100$                         |                                      | mA    |
| $T_{STG}$ | Storage Temperature Range        | -65 to +150                       |                                      | °C    |
| MSL       | Moisture Sensitivity             |                                   | Level 1                              |       |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1.  $I_O$  absolute maximum rating must be observed.

## RECOMMENDED OPERATING CONDITIONS

| Symbol              | Parameter                                                                                                                                               | Min        | Typ                  | Max              | Units |
|---------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|------------|----------------------|------------------|-------|
| $V_{CC}$            | Supply Voltage<br>Operating<br>Data Retention Only                                                                                                      | 2.0<br>1.5 | 2.5, 3.3<br>2.5, 3.3 | 3.6<br>3.6       | V     |
| $V_I$               | Input Voltage                                                                                                                                           | 0          |                      | 5.5              | V     |
| $V_O$               | Output Voltage<br>(HIGH or LOW State)<br>(3-State)                                                                                                      | 0<br>0     |                      | $V_{CC}$<br>5.5  | V     |
| $I_{OH}$            | HIGH Level Output Current<br>$V_{CC} = 3.0\text{ V} - 3.6\text{ V}$<br>$V_{CC} = 2.7\text{ V} - 3.0\text{ V}$<br>$V_{CC} = 2.3\text{ V} - 2.7\text{ V}$ |            |                      | -24<br>-12<br>-8 | mA    |
| $I_{OL}$            | LOW Level Output Current<br>$V_{CC} = 3.0\text{ V} - 3.6\text{ V}$<br>$V_{CC} = 2.7\text{ V} - 3.0\text{ V}$<br>$V_{CC} = 2.3\text{ V} - 2.7\text{ V}$  |            |                      | +24<br>+12<br>+8 | mA    |
| $T_A$               | Operating Free-Air Temperature                                                                                                                          | -40        |                      | +85              | °C    |
| $\Delta t/\Delta V$ | Input Transition Rise or Fall Rate, $V_{IN}$ from 0.8 V to 2.0 V, $V_{CC} = 3.0\text{ V}$                                                               | 0          |                      | 10               | ns/V  |

# MC74LCX373

## DC ELECTRICAL CHARACTERISTICS

| Symbol           | Characteristic                        | Condition                                                                                                        | T <sub>A</sub> = -40°C to +85°C |      | Units |
|------------------|---------------------------------------|------------------------------------------------------------------------------------------------------------------|---------------------------------|------|-------|
|                  |                                       |                                                                                                                  | Min                             | Max  |       |
| V <sub>IH</sub>  | HIGH Level Input Voltage (Note 2)     | 2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V                                                                                  | 1.7                             |      | V     |
|                  |                                       | 2.7 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                                                  | 2.0                             |      |       |
| V <sub>IL</sub>  | LOW Level Input Voltage (Note 2)      | 2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V                                                                                  |                                 | 0.7  | V     |
|                  |                                       | 2.7 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                                                  |                                 | 0.8  |       |
| V <sub>OH</sub>  | HIGH Level Output Voltage             | 2.3 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OL</sub> = 100 μA                                                        | V <sub>CC</sub> - 0.2           |      | V     |
|                  |                                       | V <sub>CC</sub> = 2.3 V; I <sub>OH</sub> = -8 mA                                                                 | 1.8                             |      |       |
|                  |                                       | V <sub>CC</sub> = 2.7 V; I <sub>OH</sub> = -12 mA                                                                | 2.2                             |      |       |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -18 mA                                                                | 2.4                             |      |       |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -24 mA                                                                | 2.2                             |      |       |
| V <sub>OL</sub>  | LOW Level Output Voltage              | 2.3 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OL</sub> = 100 μA                                                        |                                 | 0.2  | V     |
|                  |                                       | V <sub>CC</sub> = 2.3 V; I <sub>OL</sub> = 8 mA                                                                  |                                 | 0.6  |       |
|                  |                                       | V <sub>CC</sub> = 2.7 V; I <sub>OL</sub> = 12 mA                                                                 |                                 | 0.4  |       |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 16 mA                                                                 |                                 | 0.4  |       |
|                  |                                       | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 24 mA                                                                 |                                 | 0.55 |       |
| I <sub>OZ</sub>  | 3-State Output Current                | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> ,<br>V <sub>OUT</sub> = 0 to 5.5 V |                                 | ±5   | μA    |
| I <sub>OFF</sub> | Power Off Leakage Current             | V <sub>CC</sub> = 0, V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V                                         |                                 | 10   | μA    |
| I <sub>IN</sub>  | Input Leakage Current                 | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = 5.5 V or GND                                                          |                                 | ±5   | μA    |
| I <sub>CC</sub>  | Quiescent Supply Current              | V <sub>CC</sub> = 3.6 V, V <sub>IN</sub> = 5.5 V or GND                                                          |                                 | 10   | μA    |
| ΔI <sub>CC</sub> | Increase in I <sub>CC</sub> per Input | 2.3 ≤ V <sub>CC</sub> ≤ 3.6 V; V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V                                         |                                 | 500  | μA    |

2. These values of V<sub>I</sub> are used to test DC electrical characteristics only.

## AC CHARACTERISTICS (t<sub>R</sub> = t<sub>F</sub> = 2.5 ns; R<sub>L</sub> = 500 Ω)

| Symbol                                 | Parameter                                             | Waveform | Limits                          |            |                         |            |                                 |              | Units |
|----------------------------------------|-------------------------------------------------------|----------|---------------------------------|------------|-------------------------|------------|---------------------------------|--------------|-------|
|                                        |                                                       |          | T <sub>A</sub> = -40°C to +85°C |            |                         |            |                                 |              |       |
|                                        |                                                       |          | V <sub>CC</sub> = 3.3 V ± 0.3 V |            | V <sub>CC</sub> = 2.7 V |            | V <sub>CC</sub> = 2.5 V ± 0.2 V |              |       |
|                                        |                                                       |          | C <sub>L</sub> = 50 pF          |            | C <sub>L</sub> = 50 pF  |            | C <sub>L</sub> = 30 pF          |              |       |
|                                        |                                                       |          | Min                             | Max        | Min                     | Max        | Min                             | Max          |       |
| t <sub>PLH</sub><br>t <sub>PHL</sub>   | Propagation Delay<br>D <sub>n</sub> to O <sub>n</sub> | 1        | 1.5<br>1.5                      | 8.0<br>8.0 | 1.5<br>1.5              | 9.0<br>9.0 | 1.5<br>1.5                      | 9.6<br>9.6   | ns    |
| t <sub>PLH</sub><br>t <sub>PHL</sub>   | Propagation Delay<br>LE to O <sub>n</sub>             | 3        | 1.5<br>1.5                      | 8.5<br>8.5 | 1.5<br>1.5              | 9.5<br>9.5 | 1.5<br>1.5                      | 10.5<br>10.5 | ns    |
| t <sub>PZH</sub><br>t <sub>PZL</sub>   | Output Enable Time to HIGH<br>and LOW Level           | 2        | 1.5<br>1.5                      | 8.5<br>8.5 | 1.5<br>1.5              | 9.5<br>9.5 | 1.5<br>1.5                      | 10.5<br>10.5 | ns    |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub>   | Output Disable Time From<br>High and Low Level        | 2        | 1.5<br>1.5                      | 7.5<br>7.5 | 1.5<br>1.5              | 8.5<br>8.5 | 1.5<br>1.5                      | 9.0<br>9.0   | ns    |
| t <sub>s</sub>                         | Setup Time, HIGH or LOW<br>D <sub>n</sub> to LE       | 3        | 2.5                             |            | 2.5                     |            | 4.0                             |              |       |
| t <sub>h</sub>                         | Hold Time, HIGH or LOW<br>D <sub>n</sub> to LE        | 3        | 1.5                             |            | 1.5                     |            | 2.0                             |              |       |
| t <sub>w</sub>                         | LE Pulse Width, HIGH                                  | 3        | 3.3                             |            | 3.3                     |            | 4.0                             |              |       |
| t <sub>OSHL</sub><br>t <sub>OSLH</sub> | Output-to-Output Skew<br>(Note 3)                     |          |                                 | 1.0<br>1.0 |                         |            |                                 |              | ns    |

3. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

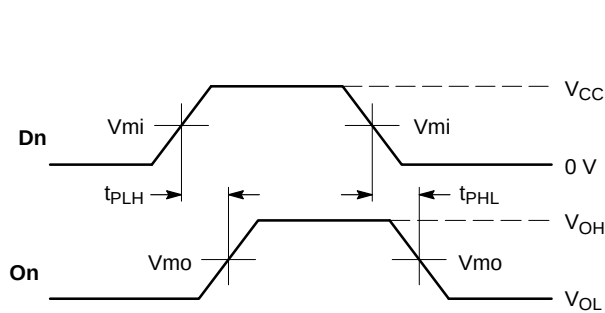
## DYNAMIC SWITCHING CHARACTERISTICS

| Symbol           | Characteristic                      | Condition                                                                                                                                                                                          | T <sub>A</sub> = +25°C |              |     | Units |
|------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|--------------|-----|-------|
|                  |                                     |                                                                                                                                                                                                    | Min                    | Typ          | Max |       |
| V <sub>OLP</sub> | Dynamic LOW Peak Voltage (Note 4)   | V <sub>CC</sub> = 3.3 V, C <sub>L</sub> = 50 pF, V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V<br>V <sub>CC</sub> = 2.5 V, C <sub>L</sub> = 30 pF, V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V |                        | 0.8<br>0.6   |     | V     |
| V <sub>OLV</sub> | Dynamic LOW Valley Voltage (Note 4) | V <sub>CC</sub> = 3.3 V, C <sub>L</sub> = 50 pF, V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V<br>V <sub>CC</sub> = 2.5 V, C <sub>L</sub> = 30 pF, V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V |                        | -0.8<br>-0.6 |     | V     |

4. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

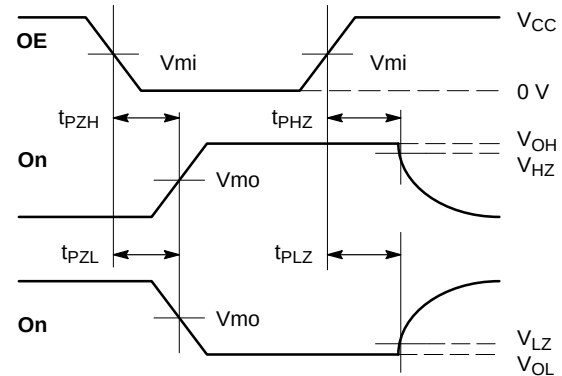
## CAPACITIVE CHARACTERISTICS

| Symbol           | Parameter                     | Condition                                                                | Typical | Units |
|------------------|-------------------------------|--------------------------------------------------------------------------|---------|-------|
| C <sub>IN</sub>  | Input Capacitance             | V <sub>CC</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CC</sub>         | 7       | pF    |
| C <sub>I/O</sub> | Input/Output Capacitance      | V <sub>CC</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CC</sub>         | 8       | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance | 10 MHz, V <sub>CC</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CC</sub> | 25      | pF    |



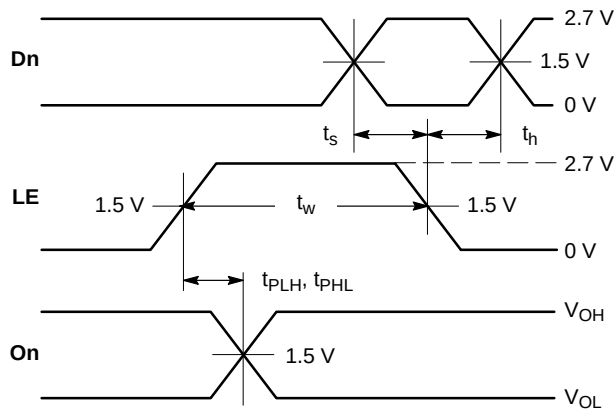
**WAVEFORM 1 – PROPAGATION DELAYS**

t<sub>R</sub> = t<sub>F</sub> = 2.5 ns, 10% to 90%; f = 1 MHz; t<sub>W</sub> = 500 ns



**WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES**

t<sub>R</sub> = t<sub>F</sub> = 2.5 ns, 10% to 90%; f = 1 MHz; t<sub>W</sub> = 500 ns



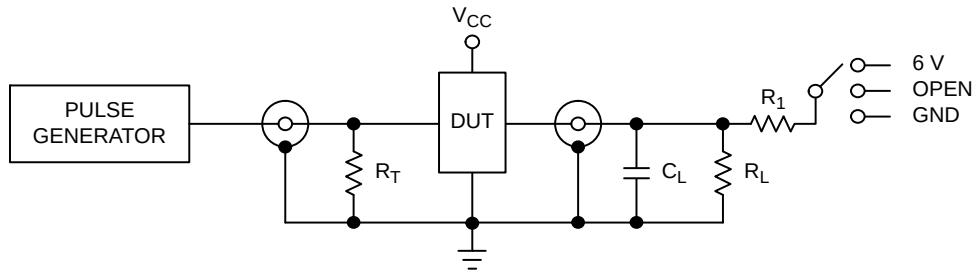
**WAVEFORM 3 – LE to On PROPAGATION DELAYS, LE MINIMUM PULSE WIDTH, Dn to LE SETUP AND HOLD TIMES**

t<sub>R</sub> = t<sub>F</sub> = 2.5 ns, 10% to 90%; f = 1 MHz; t<sub>W</sub> = 500 ns except when noted

| Symbol          | V <sub>CC</sub>         |                         |                          |
|-----------------|-------------------------|-------------------------|--------------------------|
|                 | 3.3 V ± 0.3 V           | 2.7 V                   | 2.5 V ± 0.2 V            |
| V <sub>mi</sub> | 1.5 V                   | 1.5 V                   | V <sub>CC</sub> /2       |
| V <sub>mo</sub> | 1.5 V                   | 1.5 V                   | V <sub>CC</sub> /2       |
| V <sub>HZ</sub> | V <sub>OL</sub> + 0.3 V | V <sub>OL</sub> + 0.3 V | V <sub>OL</sub> + 0.15 V |
| V <sub>LZ</sub> | V <sub>OH</sub> - 0.3 V | V <sub>OH</sub> - 0.3 V | V <sub>OH</sub> - 0.15 V |

**Figure 3. AC Waveforms**

## MC74LCX373



| TEST                                         | SWITCH                                                             |
|----------------------------------------------|--------------------------------------------------------------------|
| $t_{PLH}$ , $t_{PHL}$                        | Open                                                               |
| $t_{PZL}$ , $t_{PLZ}$                        | 6 V at $V_{CC} = 3.3 \pm 0.3$ V<br>6 V at $V_{CC} = 2.5 \pm 0.2$ V |
| Open Collector/Drain $t_{PLH}$ and $t_{PHL}$ | 6 V                                                                |
| $t_{PZH}$ , $t_{PHZ}$                        | GND                                                                |

$C_L = 50$  pF at  $V_{CC} = 3.3 \pm 0.3$  V or equivalent (includes jig and probe capacitance)

$C_L = 30$  pF at  $V_{CC} = 2.5 \pm 0.2$  V or equivalent (includes jig and probe capacitance)

$R_L = R_1 = 500 \Omega$  or equivalent

$R_T = Z_{OUT}$  of pulse generator (typically  $50 \Omega$ )

Figure 4. Test Circuit

### ORDERING INFORMATION

| Device          | Package                 | Shipping <sup>†</sup> |
|-----------------|-------------------------|-----------------------|
| MC74LCX373DWR2G | SOIC-20 WB<br>(Pb-Free) | 1000 Tape & Reel      |
| MC74LCX373DTG   | TSSOP-20<br>(Pb-Free)   | 75 Units / Rail       |
| MC74LCX373DTR2G | TSSOP-20<br>(Pb-Free)   | 2500 Tape & Reel      |

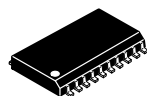
### DISCONTINUED (Note 5)

|                   |                       |                  |
|-------------------|-----------------------|------------------|
| NLV74LCX373DTR2G* | TSSOP-20<br>(Pb-Free) | 2500 Tape & Reel |
|-------------------|-----------------------|------------------|

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

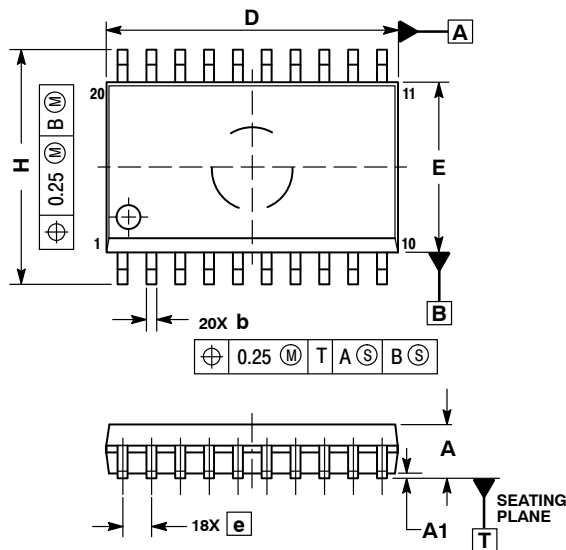
5. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on [www.onsemi.com](http://www.onsemi.com).



SCALE 1:1

SOIC-20 WB  
CASE 751D-05  
ISSUE H

DATE 22 APR 2015

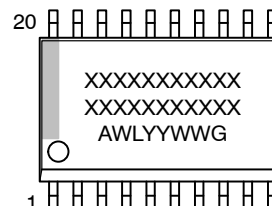


NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

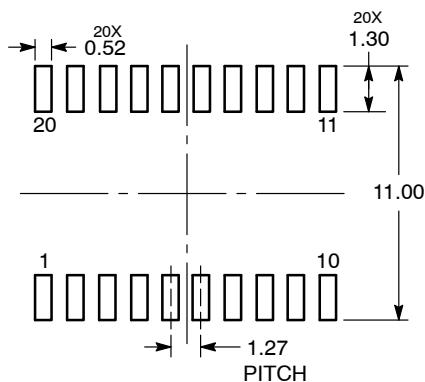
| DIM | MILLIMETERS |       |
|-----|-------------|-------|
|     | MIN         | MAX   |
| A   | 2.35        | 2.65  |
| A1  | 0.10        | 0.25  |
| b   | 0.35        | 0.49  |
| c   | 0.23        | 0.32  |
| D   | 12.65       | 12.95 |
| E   | 7.40        | 7.60  |
| e   | 1.27 BSC    |       |
| H   | 10.05       | 10.55 |
| h   | 0.25        | 0.75  |
| L   | 0.50        | 0.90  |
| θ   | 0°          | 7°    |

GENERIC  
MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

RECOMMENDED  
SOLDERING FOOTPRINT\*



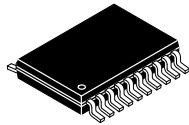
DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

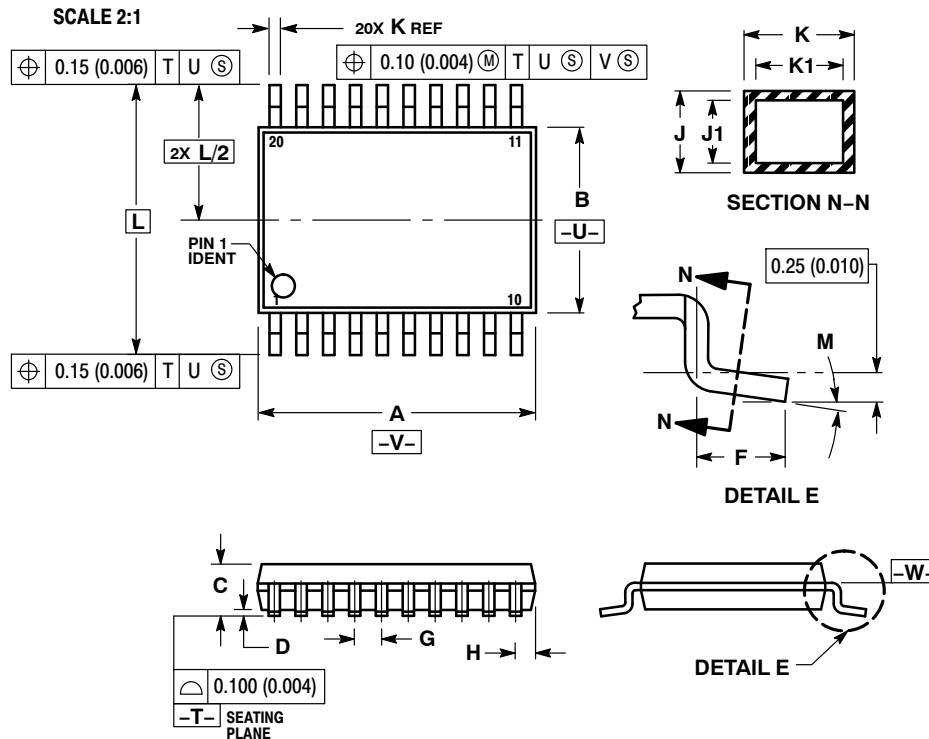
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                  |             |                                                                                                                                                                                     |
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| DESCRIPTION:     | SOIC-20 WB  | PAGE 1 OF 1                                                                                                                                                                         |

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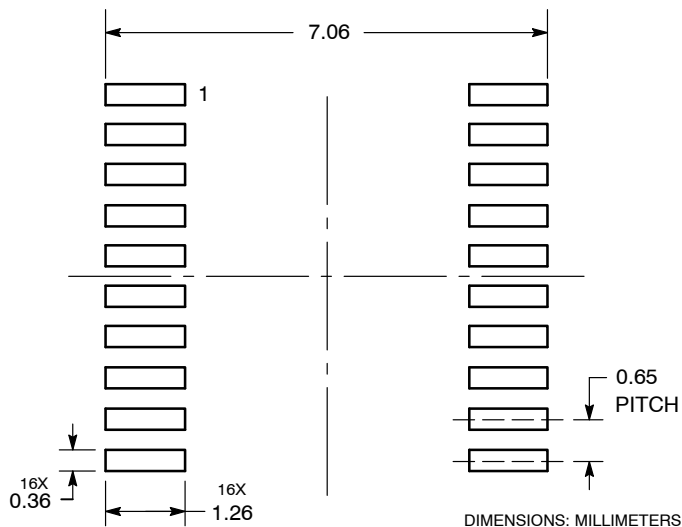

**TSSOP-20 WB**  
**CASE 948E**  
**ISSUE D**

DATE 17 FEB 2016

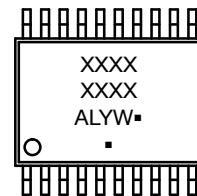

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 6.40        | 6.60 | 0.252     | 0.260 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.27        | 0.37 | 0.011     | 0.015 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

**RECOMMENDED  
SOLDERING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**GENERIC  
MARKING DIAGRAM\***


A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                         |                    |                                                                                                                                                                                     |
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| <b>DESCRIPTION:</b>     | <b>TSSOP-20 WB</b> | <b>PAGE 1 OF 1</b>                                                                                                                                                                  |

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